

## TO-252 Plastic-Encapsulate Transistors

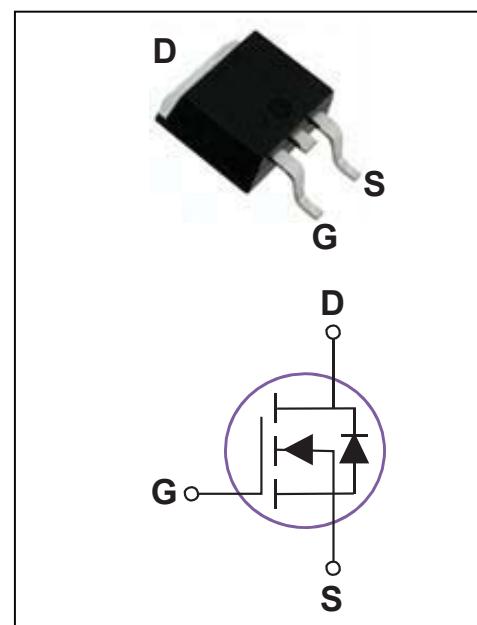
BVDSS	RDS(ON)	ID
100V	115mΩ	12A

**Features**

- 100V, 12A , RDS(ON)=115mΩ @VGS=10V
- Improved dv/dt capability
- Fast switching
- 100% EAS Guaranteed
- Green Device Available

**Applications**

- Networking
- Load Switch
- LED applications

**MAXIMUM RATINGS AND CHARACTERISTICS**

@ 250°C Ambient Temperature (unless otherwise noted)

Parameter	Symbol	Rating	Units
Drain-Source Voltage	V <sub>DS</sub>	100	V
Gate-Source Voltage	V <sub>GS</sub>	±20	V
Drain Current – Continuous (T <sub>c</sub> =25°C)	I <sub>D</sub>	12	A
Drain Current – Continuous (T <sub>c</sub> =100°C)		7.6	A
Drain Current – Pulsed <sup>1</sup>	I <sub>DM</sub>	48	A
Single Pulse Avalanche Energy <sup>2</sup>	EAS	6	mJ
Single Pulse Avalanche Current <sup>2</sup>	I <sub>AS</sub>	11	A
Power Dissipation (T <sub>c</sub> =25°C)	P <sub>D</sub>	34.7	W
Power Dissipation – Derate above 25°C		0.27	W/°C
Storage Temperature Range	T <sub>STG</sub>	-50 to 150	°C
Operating Junction Temperature Range	T <sub>J</sub>	-50 to 150	°C

**Thermal Characteristics**

Parameter	Symbol	Typ.	Max.	Unit
Thermal Resistance Junction to ambient	R <sub>θJA</sub>	---	62	°C/W
Thermal Resistance Junction to Case	R <sub>θJC</sub>	---	3.1	°C/W

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**Off Characteristics**

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Drain-Source Breakdown Voltage	$BV_{DSS}$	$V_{GS}=0V, I_D=250\mu A$	100	---	---	V
$BV_{DSS}$ Temperature Coefficient	$\Delta BV_{DSS}/\Delta T_J$	Reference to $25^\circ C, I_D=1mA$	---	0.09	---	$V/^\circ C$
Drain-Source Leakage Current	$I_{DS}$	$V_{DS}=100V, V_{GS}=0V, T_J=25^\circ C$	---	---	1	$\mu A$
		$V_{DS}=80V, V_{GS}=0V, T_J=125^\circ C$	---	---	10	$\mu A$
Gate-Source Leakage Current	$I_{GSS}$	$V_{GS}=\pm 20V, V_{DS}=0V$	---	---	$\pm 100$	nA

**On Characteristics**

Static Drain-Source On-Resistance	$R_{DS(ON)}$	$V_{GS}=10V, I_D=10A$	---	95	115	$m\Omega$
		$V_{GS}=4.5V, I_D=8A$	---	100	125	$m\Omega$
Gate Threshold Voltage	$V_{GS(th)}$	$V_{GS}=V_{DS}, I_D=250\mu A$	1.2	1.6	2.2	V
$V_{GS(th)}$ Temperature Coefficient	$\Delta V_{GS(th)}$		---	-5	---	$mV/^\circ C$
Forward Transconductance	$g_f$	$V_{DS}=10V, I_D=2A$	---	8.7	---	S

**Dynamic and switching Characteristics**

Total Gate Charge <sup>3,4</sup>	$Q_g$	$V_{DS}=50V, V_{GS}=10V, I_D=2A$	---	20	40	nC
Gate-Source Charge <sup>3,4</sup>	$Q_{gs}$		---	3.2	6	
Gate-Drain Charge <sup>3,4</sup>	$Q_{gd}$		---	3.6	7	
Turn-On Delay Time <sup>3,4</sup>	$T_{d(on)}$	$V_{DD}=50V, V_{GS}=10V, R_G=3.3\Omega$	---	18	36	ns
Rise Time <sup>3,4</sup>	$T_r$		---	4	8	
Turn-Off Delay Time <sup>3,4</sup>	$T_{d(off)}$		---	40	80	
Fall Time <sup>3,4</sup>	$T_f$		---	3	6	
Input Capacitance	$C_{iss}$	$V_{DS}=25V, V_{GS}=0V, F=1MHz$	---	1400	2800	pF
Output Capacitance	$C_{oss}$		---	60	120	
Reverse Transfer Capacitance	$C_{rss}$		---	35	70	
Gate resistance	$R_g$	$V_{GS}=0V, V_{DS}=0V, F=1MHz$	---	2	4	$\Omega$

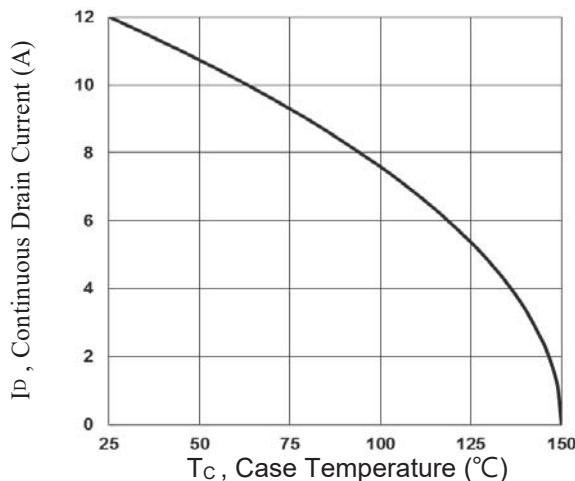
**Drain-Source Diode Characteristics and Maximum Ratings**

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Continuous Source Current	$I_s$	$V_G=V_D=0V$ , Force Current	---	---	12	A
Pulsed Source Current	$I_{SM}$		---	---	24	A
Diode Forward Voltage	$V_{SD}$	$V_{GS}=0V, I_s=1A, T_J=25^\circ C$	---	---	1	V
Reverse Recovery Time <sup>3</sup>	$t_{rr}$	$I_s=1A, dI/dt=100A/\mu s, T_J=25^\circ C$	---	38	---	ns
Reverse Recovery Charge <sup>3</sup>	$Q_{rr}$		---	27	---	nC

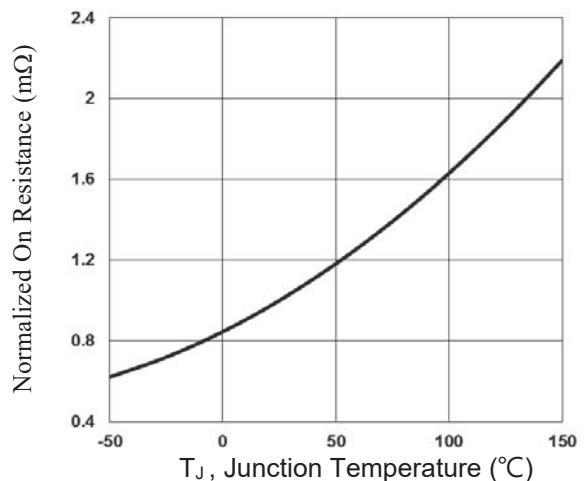
Note :

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2.  $V_{DD}=25V, V_{GS}=10V, L=0.1mH, I_{AS}=11A., R_G=25\Omega$ , Starting  $T_J=25^\circ C$ .
3. The data tested by pulsed , pulse width  $\leq 300\mu s$  , duty cycle  $\leq 2\%$ .
4. Essentially independent of operating temperature.

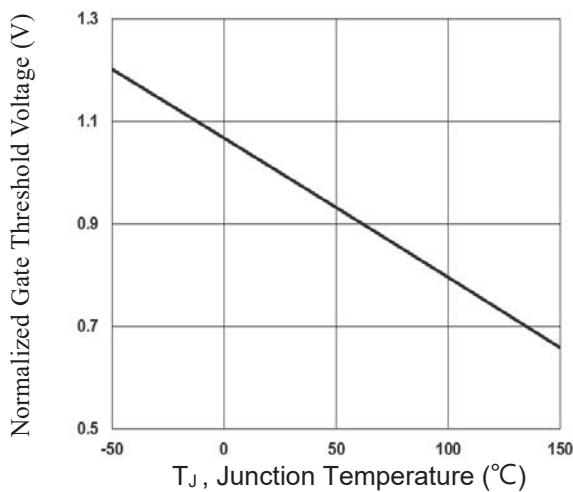
## RATINGS AND CHARACTERISTIC CURVES



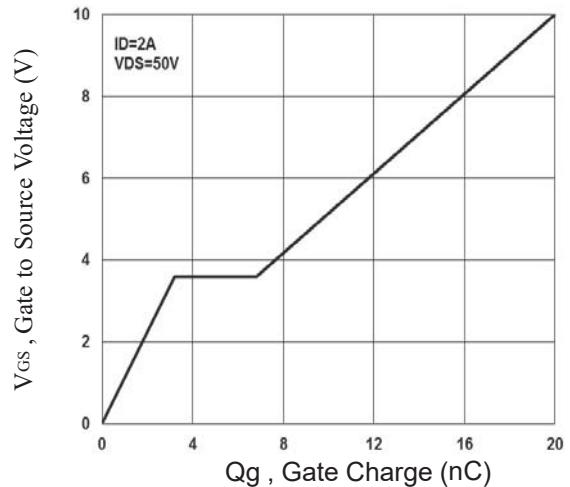
**Fig.1** Continuous Drain Current vs.  $T_c$



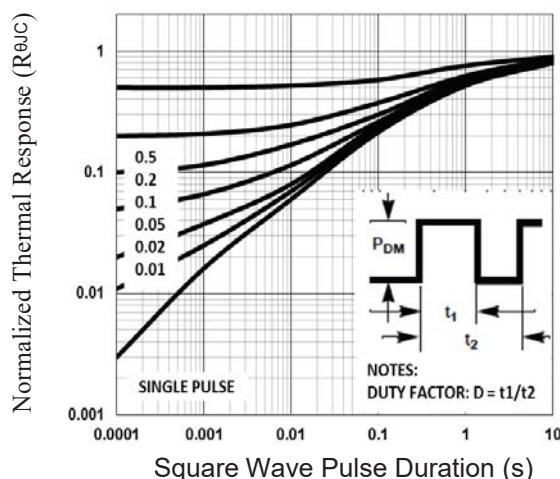
**Fig.2** Normalized  $R_{DSON}$  vs.  $T_j$



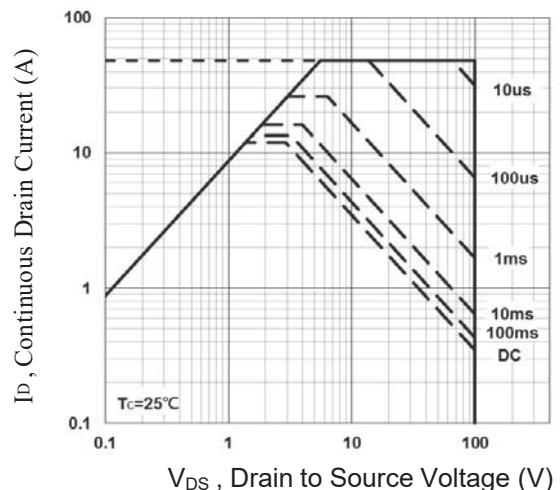
**Fig.3** Normalized  $V_{th}$  vs.  $T_j$



**Fig.4** Gate Charge Waveform



**Fig.5** Normalized Transient Impedance



**Fig.6** Maximum Safe Operation Area

## RATINGS AND CHARACTERISTIC CURVES

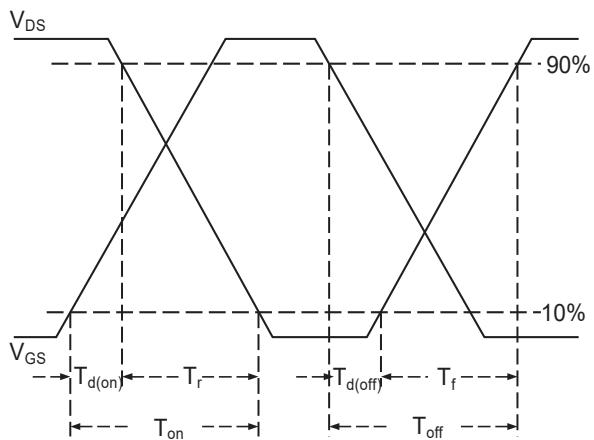


Fig.7 Switching Time Waveform

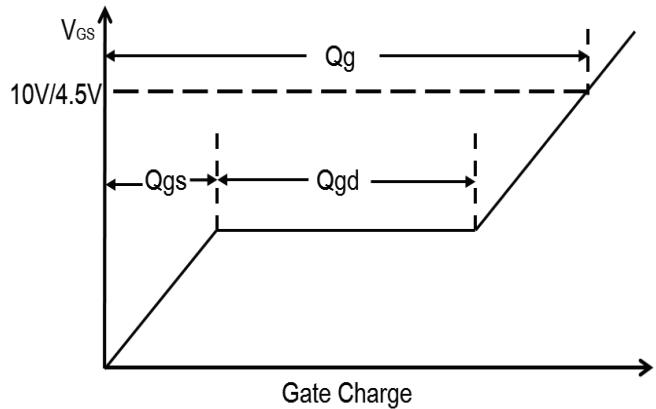
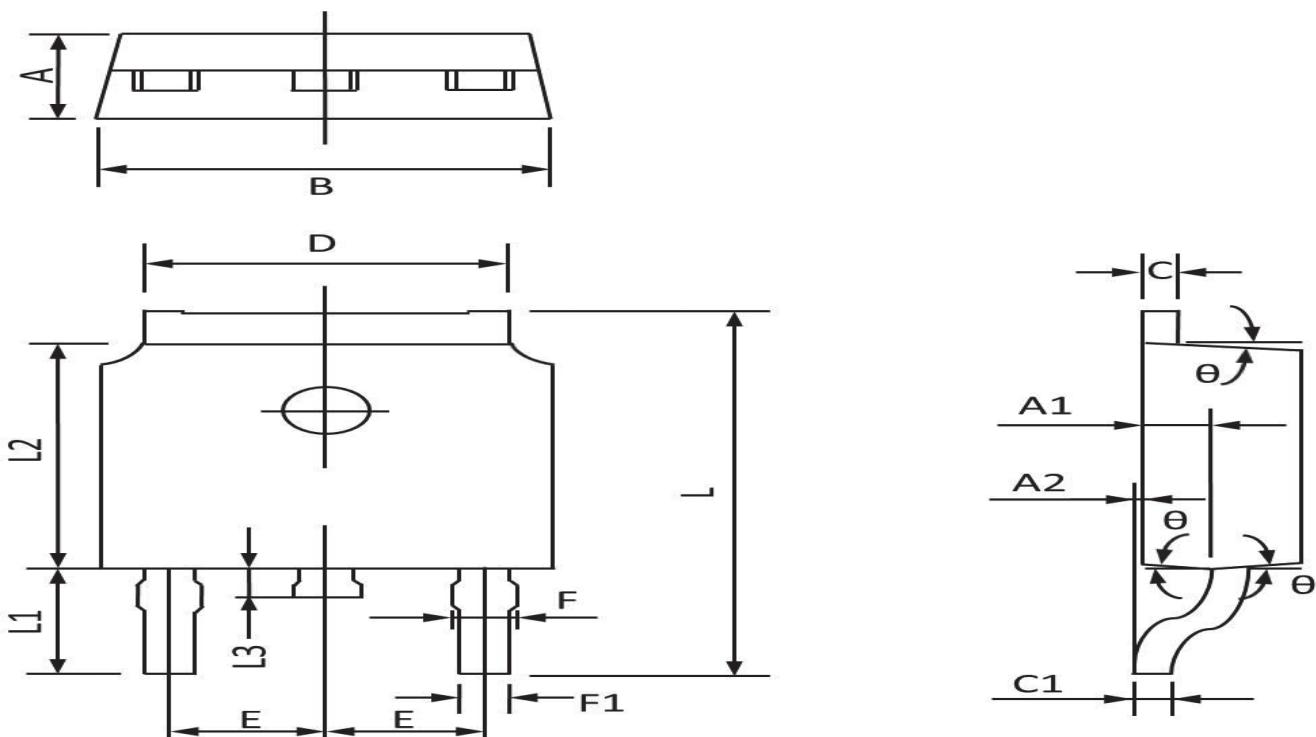


Fig.8 Gate Charge Waveform

## TO-252 PACKAGE INFORMATION



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MAX	MIN	MAX	MIN
A	2.400	2.200	0.094	0.087
A1	1.110	0.910	0.044	0.036
A2	0.150	0.000	0.006	0.000
B	6.800	6.400	0.268	0.252
C	0.580	0.450	0.023	0.018
C1	0.580	0.460	0.023	0.018
D	5.500	5.100	0.217	0.201
E	2.386	2.186	0.094	0.086
F	1.140	0.600	0.045	0.024
F1	0.880	0.500	0.035	0.020
L	10.400	9.400	0.409	0.370
L1	3.000	2.400	0.118	0.094
L2	6.223	5.400	0.245	0.213
L3	1.200	0.600	0.047	0.024
θ	9°	3°	9°	3°